

3.0x1.0mm RIGHT ANGLE SMD CHIP LED LAMP

Features

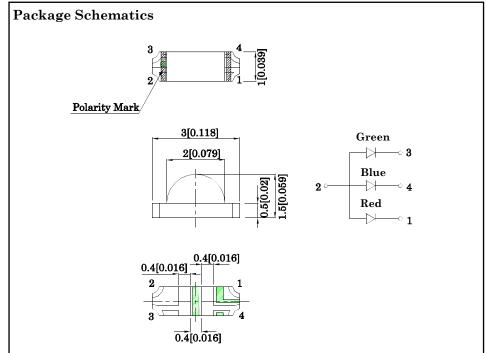
- \bullet 3.0 X 1.0 X 1.5mm right angle SMD LED
- Ideal for indication on hand held products
- Low current operation
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- ullet RoHS compliant







ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		Red (AlGaIn P)	Green (InGaN)	Blue (InGa N)	Unit
Reverse Voltage	$V_{\rm R}$	5	5	5	V
Forward Current I _F		30	25	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	185	185 150		mA
Power Dissipation		75 102.5		120	mW
Electrostatic Discharge Threshold (HBM)		3000	3000 450		V
Operating Temperature	$T_{\rm A}$	-40 ~ +85			°C
Storage Temperature	Tstg				

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics $(T_A=25$ °C)	Red (AlGaIn P)	Green (InGa N)	Blue (InGa N)	Unit	
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	1.95	3.3	3.3	V
Forward Voltage (Max.) (I_F =20mA)	$V_{\rm F}$	2.5	4.1	4.0	V
Reverse Current (Max.) $(V_R=5V)$	I_{R}	10	50	50	μА
Wavelength of Peak Emission CIE127-2007*(Typ.) (I _F =20mA)	λP	645*	515*	460*	nm
Wavelength of Dominant Emission CIE127-2007*(Typ.) (I _F =20mA)	λD	630*	525*	465*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	Δλ	28	35	25	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	35	45	100	pF

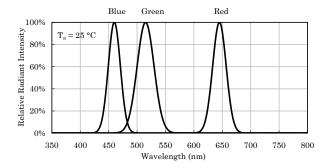
	Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I _F =20mA) mcd		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
					min.	typ.		
		Red	AlGaInP		55*	79*	645*	
	XZMDKDGCBD56W	Green	InGaN	Water Clear	300*	497*	515*	150°
	Blue	InGaN		40*	69*	460*		

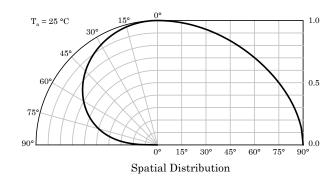
^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

Feb 25, 2019 XDSB6309 V5-Z Layout: Maggie L.

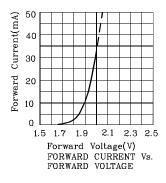


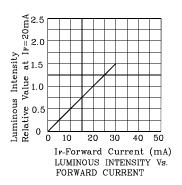


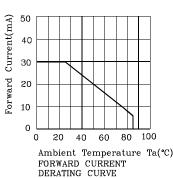


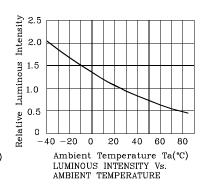


♦ Red

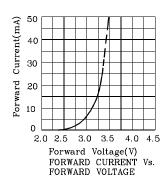


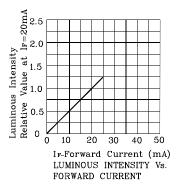


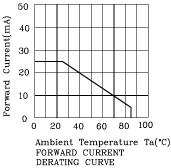


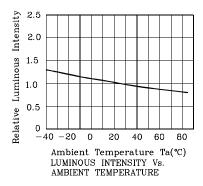


❖ Green

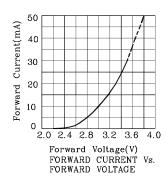


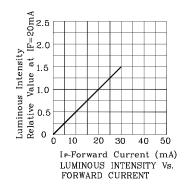


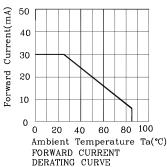


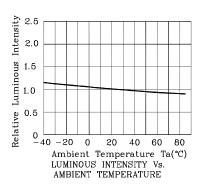


♦ Blue





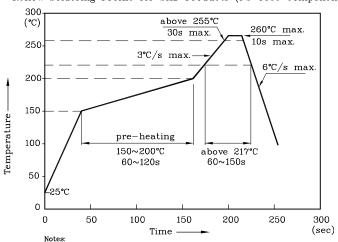






♦ LED is recommended for reflow soldering and soldering profile is shown below.

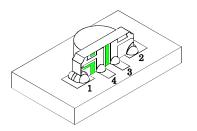
Reflow Soldering Profile for SMD Products (Pb-Free Components)



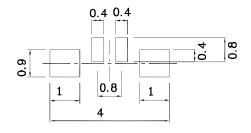
- 1. All temperatures refer to the center of the package,
- measured on the package body surface facing up during reflow.

 2. Do not apply any stress to the LED during high temperature conditions.
- 3. Maximum number of soldering passes: 2

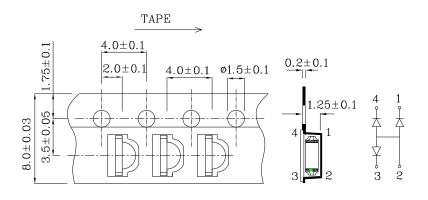
♦ The device has a single mounting surface. The device must be mounted according to the specifications.



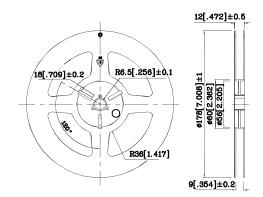
♦ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



❖ Tape Specification (Units:mm)



❖ Reel Dimension



Remarks:

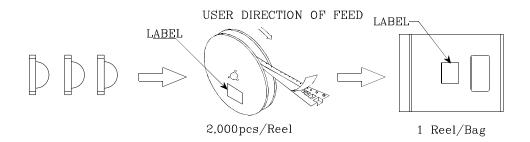
If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

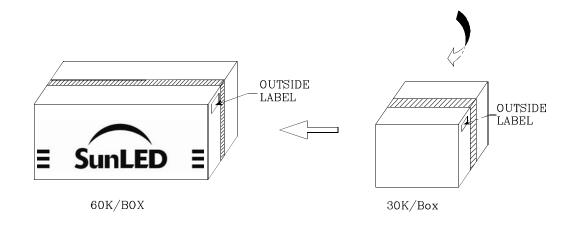
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

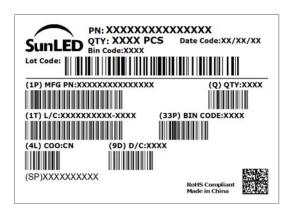
Note: Accuracy may depend on the sorting parameters.

3.0x1.0mm RIGHT ANGLE SMD CHIP LED LAMP

PACKING & LABEL SPECIFICATIONS







TERMS OF USE

- $1.\ Data\ presented\ in\ this\ document\ reflect\ statistical\ figures\ and\ should\ be\ treated\ as\ technical\ reference\ only.$
- $2. \ Contents \ within \ this \ document \ are \ subject \ to \ improvement \ and \ enhancement \ changes \ without \ notice.$
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- 6. Additional technical notes are available at https://www.SunLEDusa.com/TechnicalNotes.asp

Feb 25, 2019 XDSB6309 V5-Z Layout: Maggie L.